

CAMTEK LTD
Form 6-K
January 07, 2016

UNITED STATES
SECURITIES AND EXCHANGE COMMISSION
Washington, D.C. 20549

FORM 6-K

Report of Foreign Private Issuer
Pursuant to Rule 13a-16 or 15d-16
under the Securities Exchange Act of 1934

For the Month of January 2016

CAMTEK LTD.
(Translation of Registrant's Name into English)

Ramat Gavriel Industrial Zone
P.O. Box 544
Migdal Haemek 23150
ISRAEL
(Address of Principal Corporate Offices)

Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F.

Form 20-F Form 40-F

Indicate by check mark whether the registrant by furnishing the information contained in this Form is also thereby furnishing the information to the Commission pursuant to Rule 12g3-2(b) under the Securities and Exchange Act of 1934.

Yes No

SIGNATURE

Pursuant to the requirements of the Securities Exchange Act of 1934, the Registrant has duly caused this report to be signed on its behalf by the undersigned, thereunto duly authorized.

CAMTEK LTD.
(Registrant)

By: /s/ Moshe Eisenberg

Moshe Eisenberg,

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Chief Financial Officer

Dated: January 7, 2016

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FOR IMMEDIATE RELEASE

**CAMTEK RECEIVES OVER \$3 MILLION MULTIPLE SYSTEMS REPEAT ORDERS
FROM A GLOBAL OSAT**

The systems will be used for the inspection and metrology of Advanced Packaging

MIGDAL HAEMEK, Israel – January 7, 2016 – Camtek Ltd. (NASDAQ: CAMT; TASE: CAMT), today announced the receipt of repeat orders for multiple systems totaling over \$3 million from a global, world leading OSAT (Outsourced Semiconductors Assembly and Test). The systems will be installed during the first quarter of 2016. The systems will be used for 3D inspection and metrology of advanced packaging applications.

Ramy Langer, Vice President and Head of Camtek's Semiconductor Division, commented, "I am happy that our systems are the tool of choice for advanced packaging applications. We have invested great effort supporting the growth of the advanced packaging market segment and are working closely with our customers on improving our systems' performance along with their product yield."

Continued Mr. Langer: "With our proven history of results in 3D metrology demonstrated at multiple customers, I am confident that our newly launched capabilities for 2D inspection will gain a significant market share in the short term and become the ultimate tool for 2D inspection and metrology."

ABOUT CAMTEK LTD.

Camtek Ltd. provides automated and technologically advanced solutions dedicated to enhancing production processes, increasing products yield and reliability, enabling and supporting customer's latest technologies in the Semiconductors, Printed Circuit Boards (PCB) and IC Substrates industries.

Camtek addresses the specific needs of these interconnected industries with dedicated solutions based on a wide and advanced platform of technologies including intelligent imaging, image processing and functional 3D inkjet printing.

This press release is available at www.camtek.com

This press release may contain projections or other forward-looking statements regarding future events or the future performance of the Company. These statements are only predictions and may change as time passes. We do not assume any obligation to update that information. Actual events or results may differ materially from those projected, including as a result of changing industry and market trends, reduced demand for our products, the timely development of our new products and their adoption by the market, increased competition in the industry, intellectual

property litigation, price reductions as well as due to risks identified in the documents filed by the Company with the SEC.
